



DMT10H015SK3

Product Summary

BV _{DSS}	R _{DS(ON)} Max	I _D T _C = +25°C
100V	14mΩ @ V _{GS} = 10V	54A
	20mΩ @ V _{GS} = 6V	45A

Description

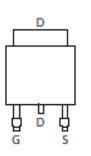
This new generation MOSFET features low on-resistance and fast switching, making it ideal for high-efficiency power management applications.

Applications

- Power Management Functions
- DC-DC Converters
- Backlighting



Top View



Pin Out Top View

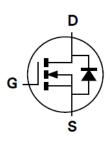
100V N-CHANNEL ENHANCEMENT MODE MOSFET

Features

- 100% Unclamped Inductive Switching (UIS) Test in Production— Ensures More Reliable and Robust End Application
- Low R_{DS(ON)} Minimizes Power Losses
- Low Q_g –Minimizes Switching Losses
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Mechanical Data

- Case: TO252
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe Solderable per MIL-STD-202, Method 208 🕲
- Weight: 0.33 grams (Approximate)



Equivalent Circuit

Ordering Information (Note 4)

Part Number	Case	Packaging			
DMT10H015SK3-13	TO252 (DPAK)	2,500/Tape & Reel			

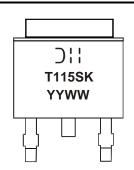
Notes: 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied. 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and

Lead-free. A block and Antimony-free "Green" products are defined as those which contain <900ppm bromine <900ppm chlorine (<1500ppm total Br + Cl) and

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



) : = Manufacturer's Marking
T115SK = Product Type Marking Code
YYWW = Date Code Marking
YY = Last Two Digits of Year (ex: 19 = 2019)
WW = Week Code (01 to 53)



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage		V _{DSS}	100	V
Gate-Source Voltage		V _{GSS}	±20	V
Continuous Drain Current, $V_{GS} = 10V$ (Note 6) $T_C = +25^{\circ}C$ $T_C = +70^{\circ}C$		I _D	54 43	A
Pulsed Drain Current (10µs Pulse, T _C =+25°C, Package Limited)	IDM	215	А	
Maximum Continuous Body Diode Forward Current (Note 6)		I _S	48	А
Pulsed Body Diode Forward Current (10µs Pulse, T _C =+25°C, Package Limited)		I _{SM}	215	А
Avalanche Current, L = 0.1mH (Note 10)		I _{AS}	15.8	А
Avalanche Energy, L = 0.1mH (Note 10)		E _{AS}	12.5	mJ
Avalanche Current, L = 3mH (Note 10)		I _{AS}	7.5	А
Avalanche Energy, L = 3mH (Note 10)		E _{AS}	85	mJ

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Total Power Dissipation (Note 5)		PD	1.8	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	$R_{ extsf{ heta}JA}$	69	°C/W
Total Power Dissipation (Note 6)		PD	2.9	W
Thermal Resistance, Junction to Ambient (Note 6) Steady State		$R_{\theta JA}$	42	°C/W
Thermal Resistance, Junction to Case (Note 7)		R _θ JC	2	C/vv
Operating and Storage Temperature Range		T _{J,} T _{STG}	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)							
Drain-Source Breakdown Voltage	BV _{DSS}	100	_	_	V	$V_{GS} = 0V, I_D = 1mA$	
Zero Gate Voltage Drain Current	I _{DSS}	_	_	1	μA	$V_{DS} = 80V, V_{GS} = 0V$	
Gate-Source Leakage	IGSS	_	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 8)							
Gate Threshold Voltage	V _{GS(TH)}	2	-	4	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	
Static Drain-Source On-Resistance		_	11.1	14	mΩ	$V_{GS} = 10V, I_D = 20A$	
Static Drain-Source On-Resistance	R _{DS(ON)}	_	14.7	20	11122	$V_{GS} = 6V, I_D = 20A$	
Diode Forward Voltage	V _{SD}	_	_	1.3	V	$V_{GS} = 0V, I_{S} = 20A$	
DYNAMIC CHARACTERISTICS (Note 9)						-	
Input Capacitance	Ciss	_	2,343	_		$V_{DS} = 50V, V_{GS} = 0V$ f = 1MHz	
Output Capacitance	C _{oss}	_	487	_	pF		
Reverse Transfer Capacitance	Crss	_	26				
Gate Resistance	Rg	_	0.69	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge	Qg	_	30.1	_			
Gate-Source Charge	Q _{gs}	_	7.5		nC	$V_{DD} = 50V, I_D = 10A,$ $V_{GS} = 10V$	
Gate-Drain Charge	Q _{gd}	_	6.5				
Turn-On Delay Time	t _{D(ON)}	_	9.8				
Turn-On Rise Time	t _R	_	7.8			V_{DD} = 50V, V_{GS} = 10V, I_D = 10A, R_g = 6 Ω	
Turn-Off Delay Time	t _{D(OFF)}	_	22.5		ns		
Turn-Off Fall Time	tF	_	9.6]	-	
Reverse Recovery Time	t _{RR}	_	43		ns		
Reverse Recovery Charge	Q _{RR}	_	65.1	_	nC	$I_F = 10A$, di/dt = 100A/µs	

Notes: 5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.

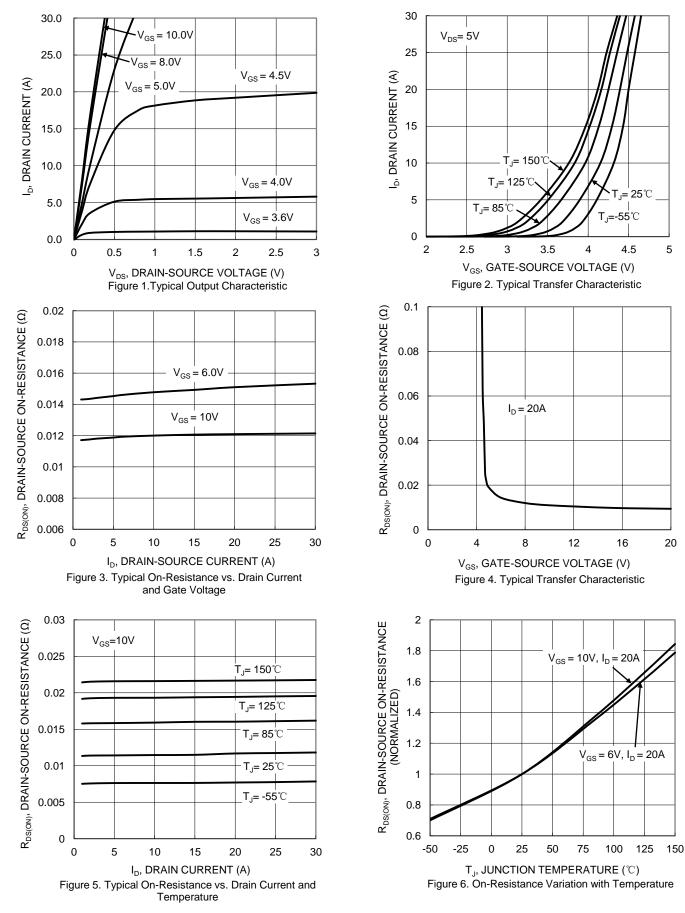
6. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

Device induction of the substate is collecting point (on the exposed drain pad).
 Short duration pulse test used to minimize self-heating effect.
 Guaranteed by design. Not subject to product testing.

10. I_{AS} and E_{AS} ratings are based on low frequency and duty cycles to keep $T_J = +25^{\circ}C$.

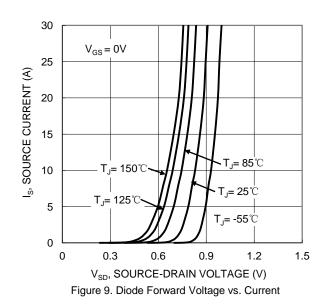


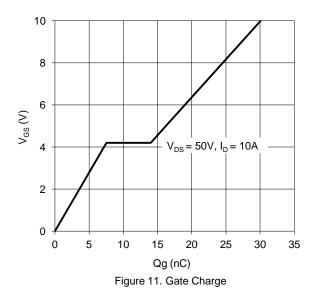
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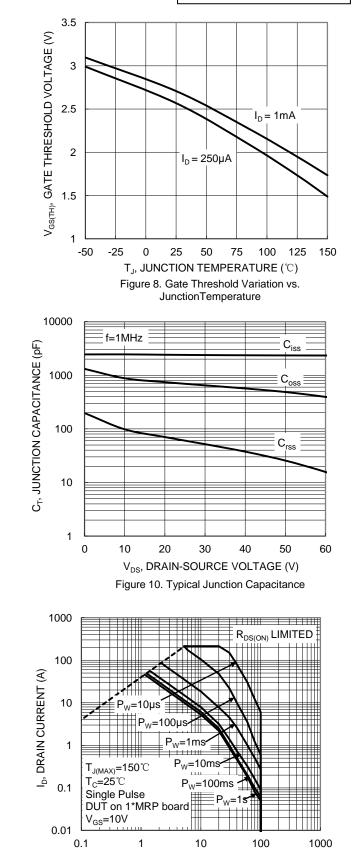




0.03 $R_{\text{DS}(\text{ON})},$ DRAIN-SOURCE ON-RESISTANCE ($\Omega)$ 0.025 $V_{GS} = 6V, I_{D} = 20A$ 0.02 0.015 $V_{GS} = 10V, I_{D} = 20A$ 0.01 0.005 -50 -25 25 50 75 100 125 150 0 T_J, JUNCTION TEMPERATURE (℃) Figure 7. On-Resistance Variation with Temperature





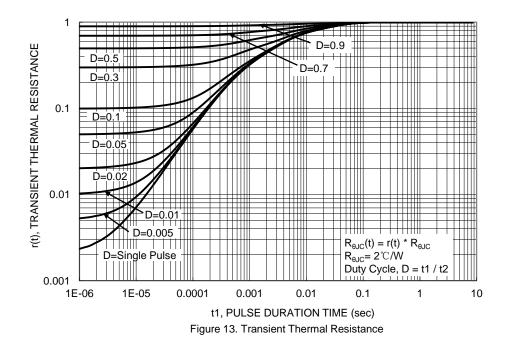


1 10 100 V_{DS}, DRAIN-SOURCE VOLTAGE (V) Figure 12. SOA, Safe Operation Area

DMT10H015SK3 Document number: DS39682 Rev. 3 - 2

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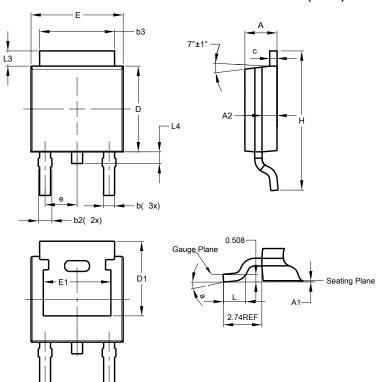






Package Outline Dimensions

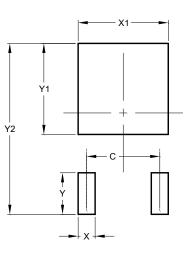
Please see http://www.diodes.com/package-outlines.html for the latest version.



TO252 (DPAK)					
Dim	Min	Max	Тур		
Α	2.19	2.39	2.29		
A1	0.00	0.13	0.08		
A2	0.97	1.17	1.07		
b	0.64	0.88	0.783		
b2	0.76	1.14	0.95		
b3	5.21	5.46	5.33		
C	0.45	0.58	0.531		
D	6.00	6.20	6.10		
D1	5.21	-	-		
е	-	-	2.286		
Е	6.45	6.70	6.58		
E1	1 4.32		-		
Н	9.40	10.41	9.91		
L	1.40	1.78	1.59		
L3	0.88	1.27	1.08		
L4	0.64	1.02	0.83		
а	0°	10°	-		
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions	Value (in mm)		
С	4.572		
Х	1.060		
X1	5.632		
Y	2.600		
Y1	5.700		
Y2	10.700		

TO252 (DPAK)

TO252 (DPAK)



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